MAINTENANCE MANUAL 406-512 MHz RF ASSEMBLIES 19D417075G9-G38, 19B233690G1-G20 AND IF FILTER BOARDS 19C320523G2-G3, 19C331148G1-G2

TABLE OF CONTENTS Page DESCRIPTION Front CIRCUIT ANALYSIS Front MODIFICATIONS 1 0UTLINE DIAGRAMS 2 & 5 SCHEMATIC DIAGRAMS 3, 6 & 8 RF Assembly 3, 6 & 8 IF Filter Board 4, 7 & 9 PARTS LIST 10 PRODUCTION CHANGES 12

DESCRIPTION

The RF Assembly uses five tuned helical resonators to provide front end RF selectivity with no gain. A UHS preamplifier assembly is available that can be used with the receiver to improve sensitivity.

Mixer board A303 uses the RF signal from the RF Assembly and the mixer injection frequency from the oscillator multiplier board to generate the IF frequency.

CIRCUIT ANALYSIS

RF ASSEMBLY

Pre-Amplifier

The pre-amplifier is present only in UHS receivers, and uses a bi-polar transistor to provide approximately 10 dB gain.

RF from the antenna is link-coupled through helical resonator L2301 to the base of Class A pre-amplifier Q2301. L2301 matches the 50 ohm input to the base of Q2301. The amplified output is coupled through L2302, and connected through W2301 to J1 on Antenna Input

Board A301. P2301 connects to J502 on the IF-Filter Board for regulated +10 Volt supply voltage.

Antenna Input A301A/A301B/A3O1C

An RF signal from the antenna or UHS pre-amplifier is applied to A301 which provides an AC ground between vehicle ground and receiver A-. Resistor R1 prevents a static charge from building up on the vehicle antenna. The output of A3O1 is coupled through five high Q helical resonators that provide the front end RF selectivity. The helicals are tuned to the in coming frequency by C301 through C305.

Mixer A304

The mixer uses a FET (Q1) as the active device. The FET mixer provides a high input impedance, high power gain and an output relatively free of harmonics (low in intermodulation products).

In the mixer stage, RF from the helical resonators is coupled through L1 and C2 which matches the RF output to the gate of mixer Q5O1. Injection voltage from the multiplier-selectivity stages is applied to the source of the mixer. The 11.2 MHz mixer IF output signal is coupled from the drain of Q1 through Cable W1 to J501 on the IF Filter board.



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Mountain View Road
Lynchburg, Virginia 24502
1-800-528-7711 (Outside USA, 804-528-7711)

IF FILTER

Crystal Filter

The output of A303-Q1 is coupled through a tuned circuit (L507 & C515) which matches the out put to the input of the four-pole monolithic crystal filter. The highly-selective crystal filter (FL501 & FL502) provides the first portion of the receiver IF selectivity. The output of the filter is coupled through impedance matching network L503 and C511 to the IF amplifier

<u>Service Note:</u> Variable capacitor C504 does not require adjustment when performing normal alignment. If the four-pole monolithic crystal filter is replaced, then adjustment of C504 is necessary for optimum IF response.

IF Amplifier

IF Amplifier Q501 is a dual-gate FET. The filter output is applied to Gate 1 of the amplifier, and the output is taken from the drain. The biasing on Gate 2 and the drain load determines the gain of the stage. The amplifier provides approximately 20 dB of IF gain. The output of Q501 is coupled through a network (L504 & C509) that matches the amplifier output to the crystal filter on the IFAS board. The output of the IF-Filter board is applied to the IFAS board through feed-through capacitor C325.

Supply voltage for the RF amplifier and IF-Filter board is supplied from the IFAS board through feed-through capacitor C326.

MODIFICATIONS

Some of the RF amplifier assemblies are not compatible with some of the IF-Filter boards without a modification to the RF assembly mixer board. Refer to the compatibility chart shown below.

RF ASSEMBLY	COMPATIBLE WITH IF-FILTER BOARD
19D417075G9-G18	19C320523G2
19B233690G1-G10	19C331148G1

The following modifications are provided to permit field replacement using incompatible boards or assemblies. Refer to the applicable Outline Diagram for component location and printed wiring board layout.

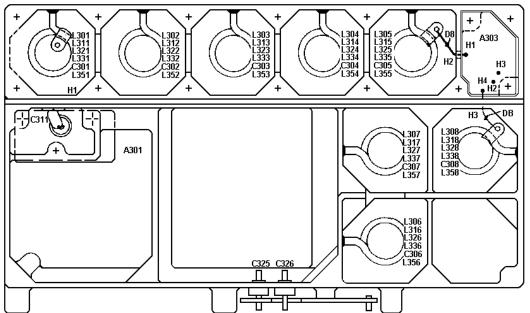
- To modify RF assemblies 19D417075G9-G18 for operation with IF-Filter board 19C331148G1: add frequency select network Z1 from the drain of mixer FET Q1 to ground. Refer to the Parts List in this manual for the correct part number.
- To modify RF assemblies 19B233690G1-G10 for operation with IF-Filter board 19C320523G2: clip out and remove frequency select network Z1 on the mixer board.

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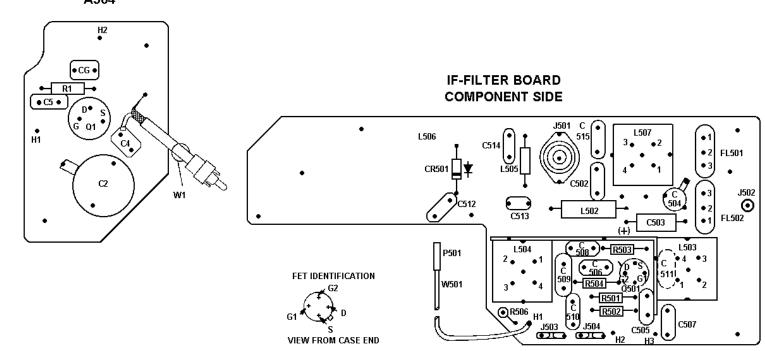
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LBI-30032 OUTLINE DIAGRAM

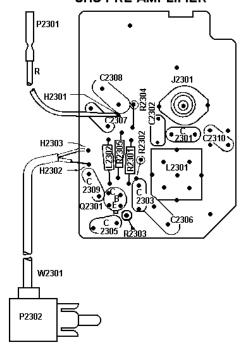
RF ASSEMBLY BOTTOM VIEW



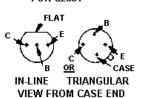
MIXER A304



UHS PRE-AMPLIFIER



OUTLINE DIAGRAM 406-512 MHz, RF ASSEMBLY BOARD 19D417075G9-G18, IF FILTER BOARD 19C320523G2 AND MIXER 19B227059G2 LEAD IDENTIFICATION FOR Q2301



NOTE: LEAD ARRANGEMENT, AND NOT CASE SHAPE, IS DETERMINING FACTOR FOR LEAD IDENTIFICATION. TAB INDICATES EMITTER LEAD.

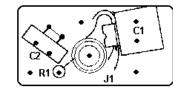
LEAD IDENTIFICATION FOR Q1



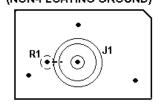
TRIANGULAR VIEW FROM CASE END

NOTE: LEAD ARRANGEMENT, AND NOT CASE SHAPE, IS DETERMINING FACTOR FOR LEAD IDENTIFICATION. TAB INDICATES EMITTER LEAD.

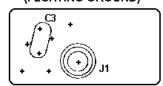
A301A ANT INPUT (FLOATING GROUND)



A301B ANT INPUT (NON-FLOATING GROUND)

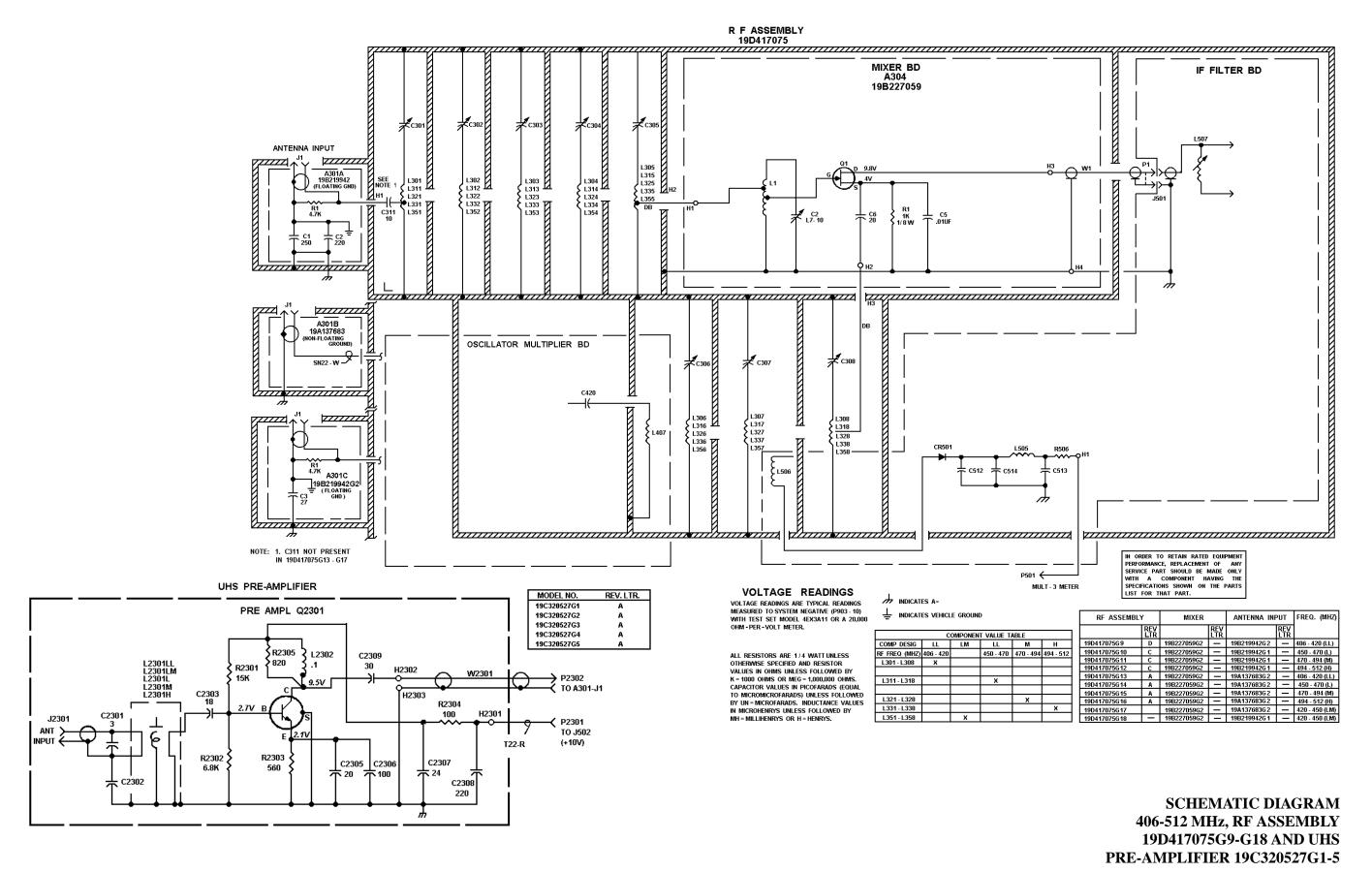


A301C ANT INPUT (FLOATING GROUND)



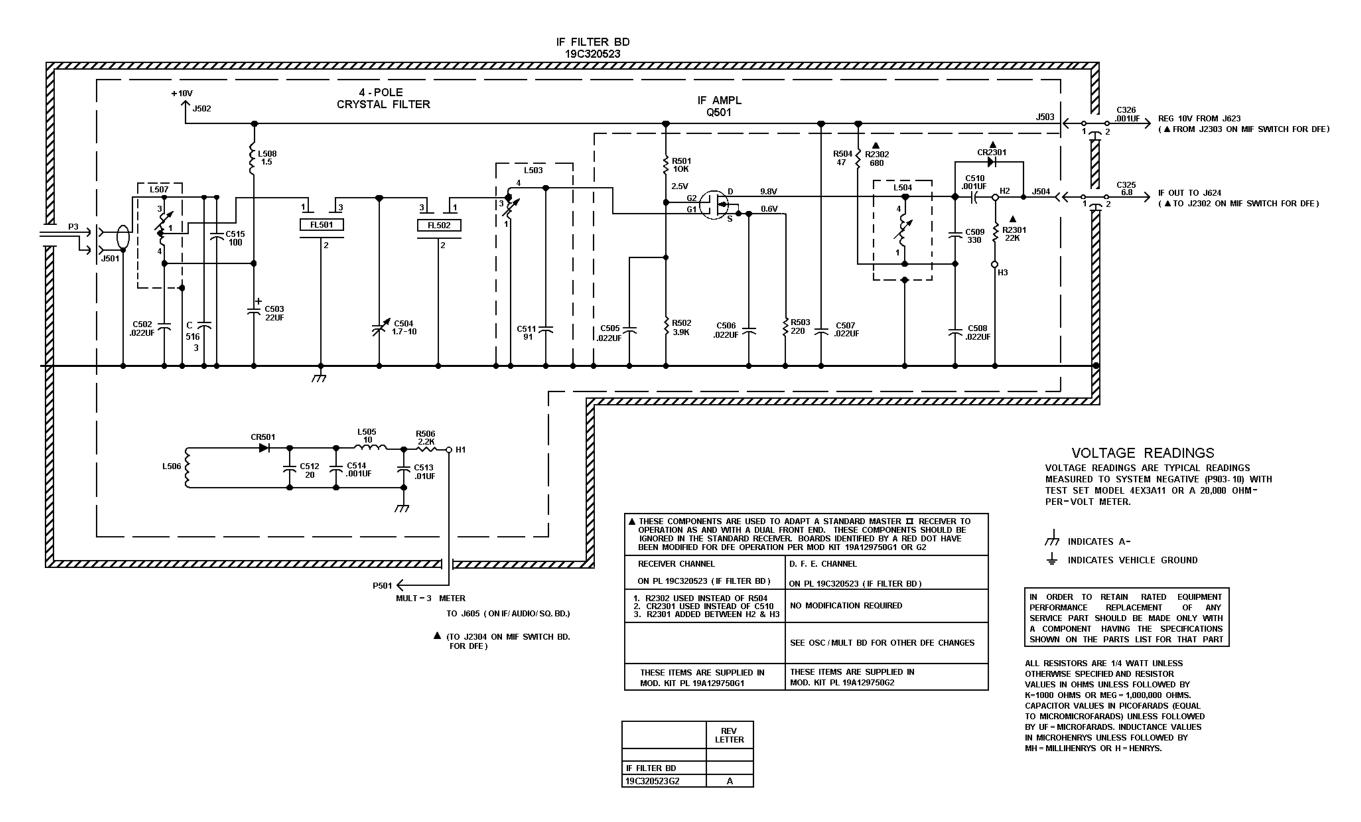
(19D423794, Rev. 10)

SCHEMATIC DIAGRAM LBI-30032



(19D423520, Rev. 8), (19B226008, Rev. 7)

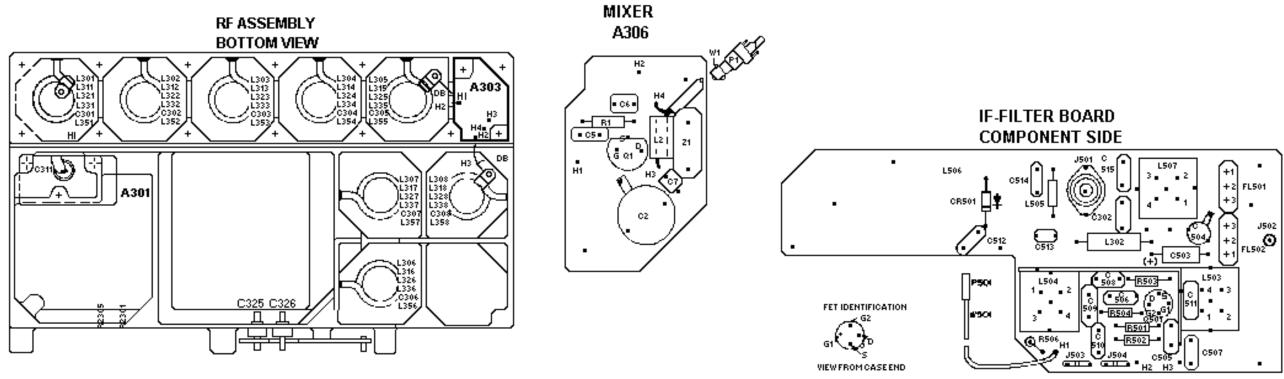
LBI-30032 SCHEMATIC DIAGRAM



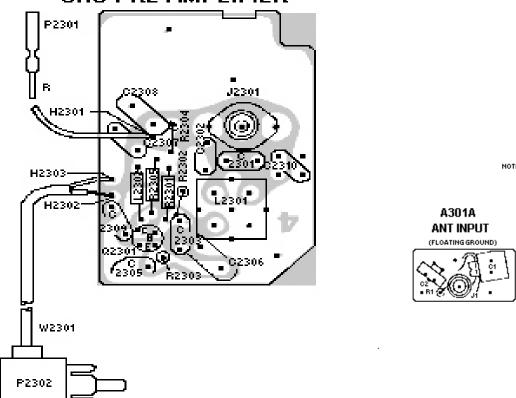
SCHEMATIC DIAGRAM IF FILTER BOARD 19C320523G2

(19D423519, Rev. 2)

OUTLINE DIAGRAM LBI-30032



UHS PRE-AMPLIFIER



LEAD IDENTIFICATION VIEW FROM CASE END NOTE: LEAD ARRANGEMENT, AND NOT

CASE SHAPE, IS DETERMINING FACTOR FOR LEAD IDENTIFICAGTION. TAB INDICATES EMITTER LEAD.

A301B **ANT INPUT** (NON-FLOATING GROUND)

...

LEAD IDENTIFICATION

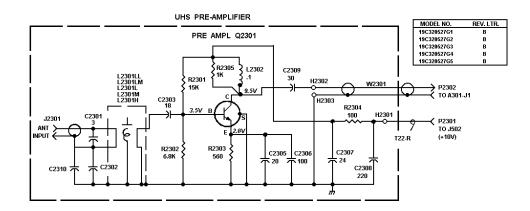


NOTE: LEAD ARRANGEMENT, AND NOT CASE SHAPE, IS DETERMINING FACTOR FOR LEAD IDENTIFICAGTION. TAB INDICATES EMITTER LEAD.

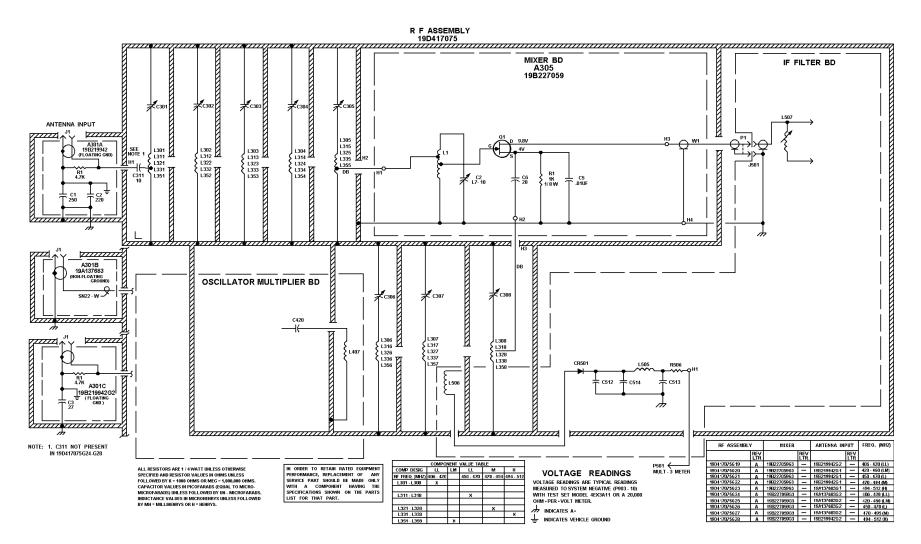
A301C ANT INPUT (FLOATING GROUND)

> **OUTLINE DIAGRAMS** 406-512 MHz, RF ASSEMBLY 19D417075G19-G28, IF-FILTER BOARD 19C331148G1-G2 AND MIXER BOARD 19B227059G3

> > (19D433377, Rev. 0)



ALL RESISTORS ARE 1 / 4 WATT UNLESS OTHERWISE SPECIFIED AND RESISTOR VALUES IN OHMS UNLESS FOLLOWED BY K = 1000 OHMS OR MEG = 1,000,000 OHMS. CAPACITOR VALUES IN PICOFARADS (EQUAL TO MICROMICROFARADS) UNLESS FOLLOWED BY UN - MICROFARADS. INDUCTANCE VALUES IN MICROHENRYS UNLESS FOLLOWED BY MH = MILLIHENRYS OR H = HENRYS.

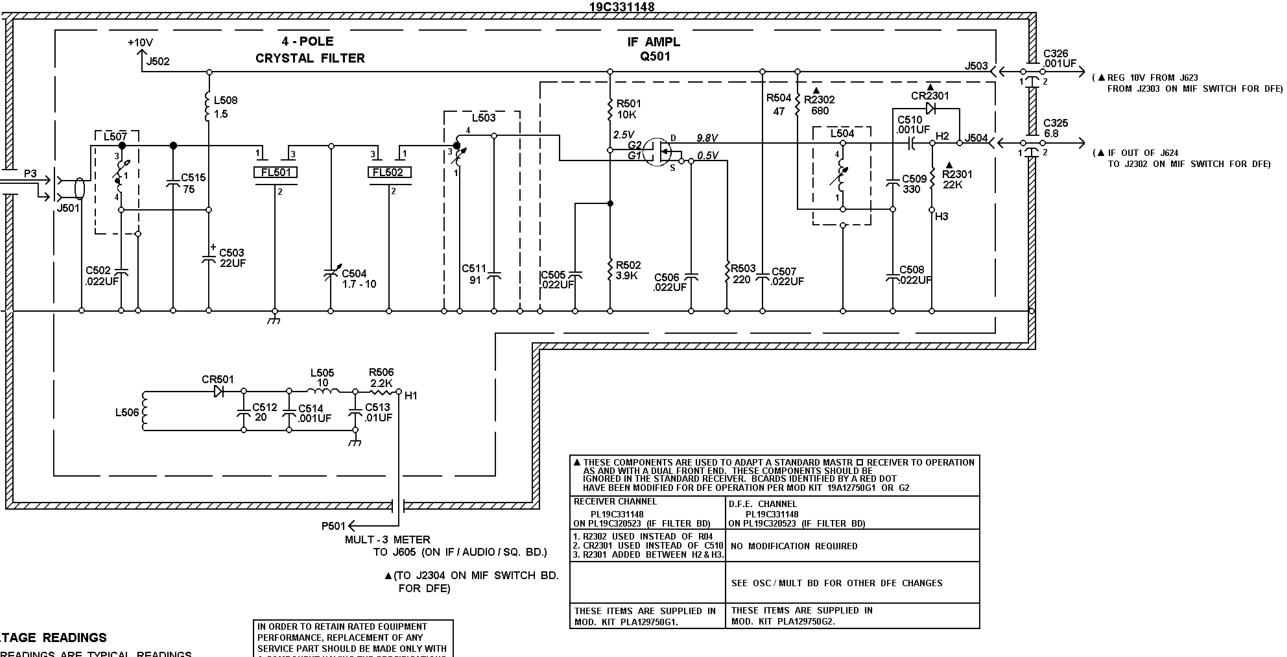


SCHEMATIC DIAGRAMS
406-512 MHz, RF ASSEMBLY
19D417075G19-G28
WITH MIXER BOARD 19B227059G3 AND
UHS PRE-AMPLIFIER 19C320527G1-G5

(19D432485, Rev. 2), (19B226008, Rev. 8)

LBI-30032 SCHEMATIC DIAGRAM

IF FILTER BD



VOLTAGE READINGS

VOLTAGE READINGS ARE TYPICAL READINGS MEASURED TO SYSTEM NEGATIVE (P903 - 101) WITH TEST SET MODEL 4EX3A11 OR A 20,000 OHM -PER - VOLT METER.

力 INDICATES A -

¥ INDICATES VEHICLE GROUND

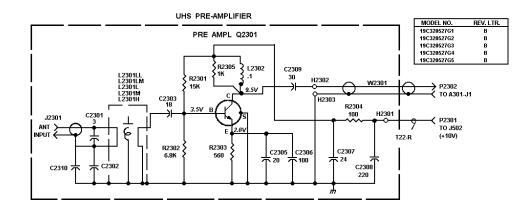
A COMPONENT HAVING THE SPECIFICATIONS SHOWN ON THE PARTS LIST FOR THAT PART.

ALL RESISTORS ARE 1/4 WATT UNLESS OTHERWISE SPECIFIED AND RESISTOR VALUES IN OHMS UNLESS FOLLOWED BY K = 1... OHMS OR MEG = 1,000,000 OHMS. CAPACITOR VALUES IN PICOFARADS (EQUAL TO MICROMICROFARADS) UNLESS FOLLOWED BY UF = MICROFARADS, INDUCTANCE VALUES IN MICROHENRYS UNLESS FOLLOWED BY MH = MILLIHENRYS OR H = HENRYS.

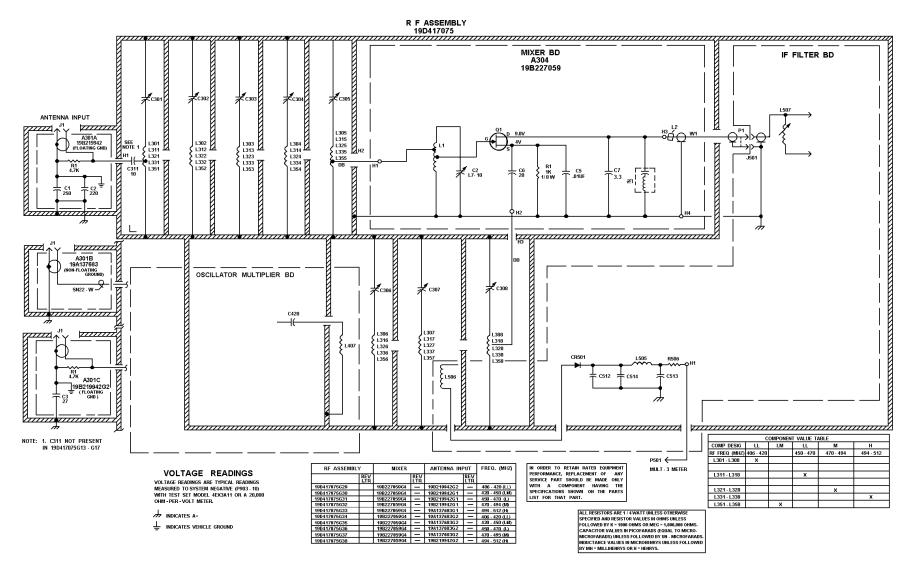
REV LETTER IF FILTER BD 19C331148G1 A

SCHEMATIC DIAGRAM IF-FILTER BOARD 19C331148G1

(19D432484, Rev. 2)



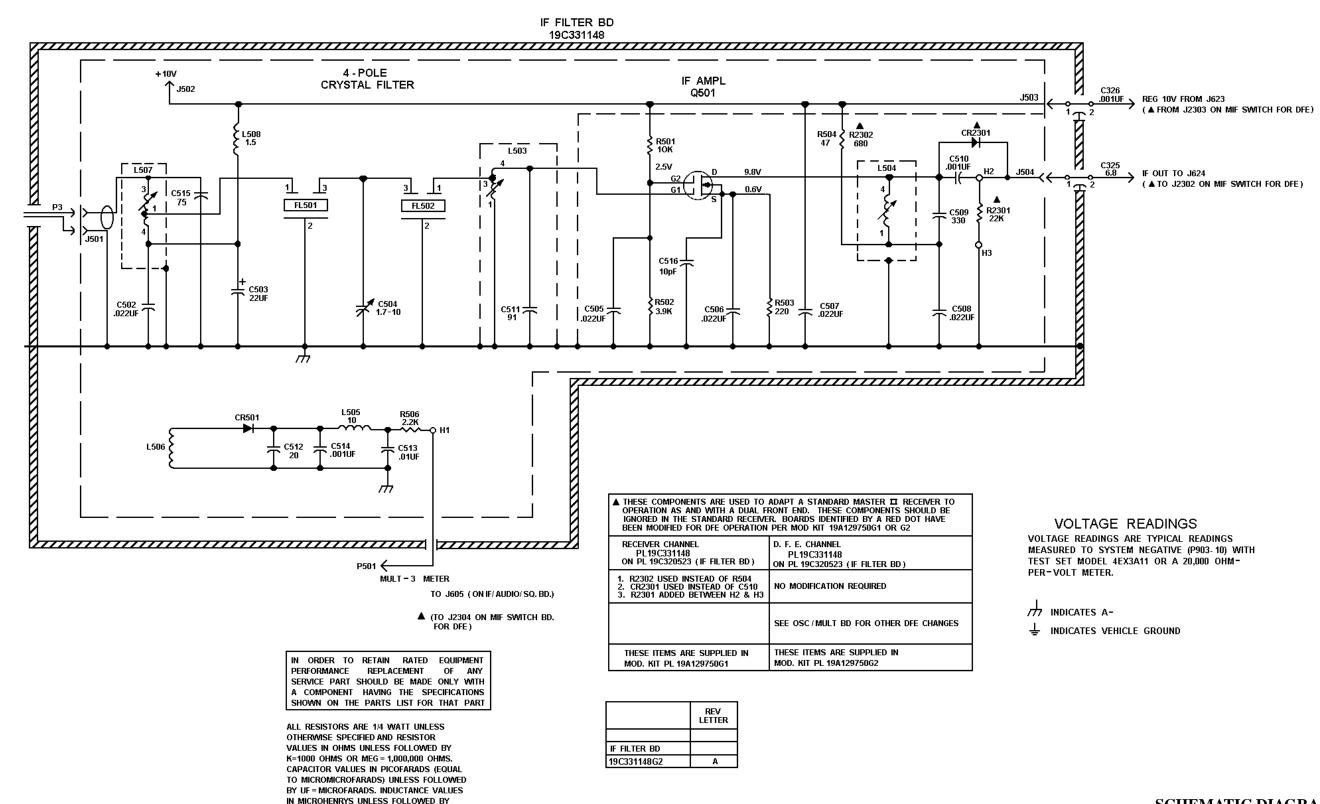
ALL RESISTORS ARE 1 / 4 WATT UNLESS OTHERWISE SPECIFIED AND RESISTOR VALUES IN OHMS UNLESS FOLLOWED BY K = 1000 OHMS OR MEG = 1,000,000 OHMS. CAPACITOR VALUES IN PICOFARADS (EQUAL TO MICRO-MICROFARADS) UNLESS FOLLOWED BY UN - MICROFARADS. INDUCTANCE VALUES IN MICROHENRYS UNLESS FOLLOWED BY MH = MILLIHENRYS OR H = HENRYS.



SCHEMATIC DIAGRAMS
406-512 MHz, RF ASSEMBLY
19D417075G29-G38
WITH MIXER BOARD 19B227059G4 AND
UHS PRE-AMPLIFIER 19C320527G1-G5

(19D433368, Rev. 0), (19B226008, Rev. 8)

SCHEMATIC DIAGRAM LBI-30032



MH = MILLIHENRYS OR H = HENRYS.

SCHEMATIC DIAGRAM IF-FILTER BOARD 19C331148G2

(19D433378, Rev. 2)

LBI-30032 PARTS LIST

PARTS LIST

406-512 MHz RECEIVER RF ASSEMBLY IF-FILTER BOARD ASSEMBLY AND UHS PRE-AMPLIFIER

SYMBOL	PART NO.	DESCRIPTION
		19D417075G9 406-420 MHz FLOATING GRD 19D417075G10 450-470 MHz FLOATING GRD 19D417075G11 470-994 MHz FLOATING GRD 19D417075G12 494-512 MHz FLOATING GRD 19D417075G13 406-420 MHz NON FLOATING GRD 19D417075G14 450-470 MHz NON FLOATING GRD 19D417075G16 494-512 MHz NON FLOATING GRD 19D417075G16 494-512 MHz NON FLOATING GRD 19D417075G17 420-450 MHz NON FLOATING GRD 19D417075G18 420-450 MHz NON FLOATING GRD 19D417075G18 420-450 MHz NON FLOATING GRD 19D417075G18 406-470 MHz NON FLOATING GRD 19D417075G21 406-470 MHz NON FLOATING GRD 19D417075G21 406-470 MHz FLOATING GRD - REV. A 19D417075G21 470-494 MHZ FLOATING GRD - REV. A
A301A* and A301C*		A301A 19821994201 450-512 MHz (Deleted in G9 by REV D). A301C 19821994202 406-420 MHz (Added to G9 by REV D).
C1	7484398P3	Silver mica: 250 pF ±10%, 500 VDCT; sim to Underwood Type 71HF.
C2	19A118679P220K	Silver Mica: 220 pF ±10%, 250 VDCW.
C3	19A116656P27J0	Ceramic disc: 27 pP ±5%, 500 VDC%, temp coef 0 PPM.
		JACKS AND RECEPTACLES
л	7104941916	Jack, phono: coaxial; sim to National Tel Barrel Ceramic.
		RESISTORS
R1	19A700106P79	Composition: 4.7% ohms ±5%, 1/4 w.
A3018*		ANTENNA IMPUT PLATE 19A137683C2 (Added to G13-G16 by REV. A)
		JACKS AND RECEPTACLES
J 1	7104941920	Jack, phono: conxis1.
A301B*		ANTENNA INPUT PLATE 19A137683G1 (Deleted in G13-G16 by REV A)
		JACKS AND RECEPTACLES
J1	7104941920	Jack, phono: coaxial.
0.1	194700100000	
R1	19A700106P79	Composition: 4.7K chms ±5%, 1/4 w.
A303 *		MIXER BOARD 19822705961 (Deleted by REV. B)
C1 C2	19A116080P103	Polyester: 0.022 uP ±10%, 50 VDCW.
C2	19A116656P2QKO	Variable, ceramic: 2 to 10 pF, 200 VDCW, temp coef -350+500 PPM; sim to Panasonic ECV-12W10X32.
		Ceramic disc: 20 pF ±10%, 500 VDCM, temp coef 0 PPM.
C4*	19A700219P14	Ceramic: 3.3 pP ±5%, 100 VDCW, texp coef 0 PPM. Earlier than NEV A:
	19A116656P3K0	Ceramic disc: 3 pF ±10%, 500 VDCW, temp coef 0 PPM.
		ELETED OR CHANGED BY PRODUCTION CHANGES

SYMBOL	PART NO.	DESCRIPTION
		INDUCTORS
L1		Part of Printed Wiring Board 190423518P1.
P1		Part of W1.
Q1	19A134093P1	N Type, field effect; sim to Type 2N4391.
R1	3R151P102K	Composition: 1K chms ±10%, 1/8 w.
W1	5491689P114	RF: approx. 5-1/8 inches long.
A304*		MIXER BOARD 198227059G2 (Added by REV. B)
		CAPACITORS
C2	19470001291	Variable, ceramic: 2 to 10 pF, 200 VDCT, temp coef -350+500 PPM; sim to Panasonic ECV-1ZM10X32.
C4*	194700219P14	Ceramic: 3.3 pF ±5%, 100 VDCW, temp coef 0 PPM. Deleted in G9-G12 by REV C, in G13-G16 by REV A.
C5	19A116192P1	Ceramic: 0.01 uP ±20%, 50 VDCW; sim to Erie 8121 Special.
CE	19A700219P39	Ceramic: 20 pF ±5%, 100 VDCW, temp coef 0 PPM.
Lì		Part of Printed Board 19D42919491.
2.		
P 1		Part of Wi.
Q1	19A134093P1	N Type field affect of Type ON Type
4-	19812408371	N Type, field effect; sim to Type 2N4391.
R1	3R151P102J	Composition: 1K ohms +5%, 1/8 w.
W1	5491689P114	RF: approx. 5-1/8 inches long. (Includes P1).
A305		MIXER BOARD 19B227059G3
C2	194700012P1	Variable ceramic: 2 to 10 pg 200 VDCF temp
C5	19411619291	Variable, ceramic: 2 to 10 pF, 200 VDCW, temp coef -350+500 PPM; sim to Panasonic ECV-12W10X32. Ceramic: 0.01 uF ±20%, 50 VDCW; sim to Erie 8121
C6	194700219939	Special. Ceramic: 20 pF ±5%, 100 VDCW, temp coef 0 PPM.
C7	194700219914	Ceramic: 20 pF ±5%, 100 VDCW, temp coef 0 PPM.
Li	1019001	Part of Printed Board 19D429194P1.
L2	19A700122P1	Torridal core.
Pl		Part of #1.
Q1	19A134093P1	N Type, field effect; sim to Type 2N4391.
		RESISTORS
RI	3R151P102J	Composition: 1K ohms ±5%, 1/8 w.
	l	

SYMBOL	PART NO.	DESCRIPTION
		CABLES
W1	5491689P114	RF: approx. 5-1/8 inches long. (Includes Pi).
Z 1	19A134666P1	Prequency network: selective, 470-630 MHz res freq, 500 VDCW; sim to Dilectrou TC501:NPO:240J:SLAC.
C301		Includes:
thru C305	19C328755P3	Screw.
	194143476G2	Nut: thd. mize No. 6-32.
C306 thru		Includes;
C308	19C328755P2	Screw.
	19A143476G2	Nut: thd. mize No. 6-32.
C311*	5496218P241	Ceramic disc: 10 pF ±5%, 500 VDCW, temp coef -80 PPM. Deleted by G13-G16 by REV A.
C325	198209488P1	Ceramic: 6.8 pF ±20%, 500 VDCW; sim to Allen Bradley Style PASD.
C326	19B209488P2	Ceramic: 1000 pF -10+100%, 500 VDCW; sim Allen Bradley Style FASD.
		INDUCTORS
L301	19B20493BG37	Co11.
L302 thru L304	19B219944Pi	Co11.
L305	19 B2049 38G33	Coil.
L306 and L307	19821994495	Coil.
L308	19B204938G41	Coil.
L311	198204938G38	Co11.
L312 thru L314	198219944P2	Coti.
1315	198204938G34	Co11.
L316 and L317	198219944P6	Co11.
L318	198204938642	Coil.
L321	1982 04 938G39	Coil.
L322 thru L324	19821994473	Co11.
L325	19B204938G35	Coil.
L326 and L327	19B219944F7	Coil.
L328	198204938G43	Co11.
L331	19B204938G40	Coil.
L332 thru L334	19B219944P4	Coll.
L335	198204938G36	Coil.
L336	198219944P8	Co11.
1337		
L338	19B204938G44	Coil.
L351	19B204938G47	Coil.
L352 thru L354	198219944P9	Coil.
L355	19B204938G48	Co11.
L356 and L357	198219944P10	Coil.
L358	198204938049	Coil.

SYMBOL	PART NO.	DESCRIPTION
		IF FILTER BOARD 19C320523G2, G3
C502	19470000599	Polyester: 0.022 uP ±10%, 50 VDCW.
C503	5496267P10	Tantalum: 22 uF ±20%, 15 VDCW; sim to Sprague Type 150D.
C504	19A700012P1	Variable, ceramic: 2 to 10 pF, 200 VDCW, temp coef -350+500 PPM; sim to Panasonic ECV-12W10X:
C505 thru C508	194700005P9	Polyester: 0.022 uF *20%, 50 VDCW.
C509	5490008P139	Silver mica: 330 pF ±10%, 500 VDCW, sim to Electro Motive Type DM-15.
C510	19A116655P19	Ceramic disc: 1000 pP +20%, 1000 VDCW; sim to RMC Type JF Discap.
C511		(Part of L503).
C512	19A116656P20E0	Ceramic disc: 20 pF ±10%, 500 VDCW, temp coef 0 PPM.
C513	194700005P7	Polyester: 0.01 uP ±10%, 50 VDCW.
C514	19A118655P20	Ceramic disc: 1000 pF ±10%, 1000 VDCW; wie to RMC Type JF Discap.
C5154	5490008P27	Silver mica: 100 pF +5%, 500 VDCW, sim to Electro Motive Type DM-15.
C515B	5490008P24	Silver mich: 75 pF ±5%, 500 VDCW, sim to Elect Motive Type DM-15.
C516*	19A118856P3K0	Ceramic disc: 3 pF +10%, 500 VDCW, temp coef 0 PPM. Added by REV A.
		DIODES AND RECTIFIERS
CR501	19A116052P1	Silicon, hot carrier: Fwd drop .350 wolts max
FL501	198219573G3	Crystal: Hesonator A - 11,200.000; Resonator 1 11,196.024 kHz.
P1.502		(Part of FL501).
		JACKS AND RECEPTACLES
J501	194700049P2	Connector, receptacle: 500 VDCW maximum; sim : NTTF-1058.
J502	4033513P1	Contact, electrical: sim to Bead Chain 193-4.
J503 and J504	19 4116975 P1	Receptacle, wire spring.
		INDUCTORS
L502*	7488079948	Coil, RF: 27 uR 10%, 1.4 ohme DC res max; sim to Jeffers 4422-9. Deleted by REV A.
L503	19032014164	Coil. Includes:
L504	5493185P9 19C320141G29	Tuning slug. Coil. Includes:
	19C320141G29 5493185P9	Cotl. Includes: Tuning slug.
L505	19A700024P25	Coil, RF: 10.0 uH ±10%, 3.70 ohms DC res max.
L506		(Part of Printed Board 190320522P1).
L507	19C321810G1	Co11.
L508	19A700000P114	Coll, RP: 1.5 uH ±10%; sim to Jeffers 4412-7K
P501		Part of W501.
Q501	19A116818P4	N Channel, field effect.
		RESISTORS
R501	19A700106P87	Composition: 10K ohms ±5%, 1/4 w.
R502	19A700106P77	Composition: 3.9K ohms ±5%, 1/4 w,

PARTS LIST LBI-30032

SYMBOL

PART NO.

DESCRIPTION

SYMBOL	PART NO.	DESCRIPTION
R503	19A700106P47	Composition: 220 ohms 15%, 1/4 w.
R504	19A700106P31	Composition: 47 ohms ±5%, 1/4 w.
R506	19A700106P71	Composition: 2.2K ohms ±5%, 1/4 w.
¥501	19A129947G7	Cable: orange, No. 22 stranded, approx. 7-1/2 inches. (Includes P501).
		UHS RP PRE-AMPLIFIER 19C320527G1 408-420 MH2 (LL) 19C320527G2 450-470 MHz (L) 19C320527G3 470-494 MHz (M) 19C320527G4 494-512 MHz (H) 19C320527G5 420-450 MHz (LM)
	1011166640010	
C2301	19A116656P3J8	Ceramic disc: 3 pF ±0.5 pF, 500 VDCW, temp coef -80 PPM.
C2302*	19A116679P220K	Silver Mica: 220 pF \pm 10%, 250 VDCW. Deleted by REV A.
C2302A*	19A134666P2	Frequency network: selective, 460-600 MHz res freq, 500 VDCW; sim to Dilectron TC501:NPO:270J:SLAC. Added by G1 & G5 by REV A.
C2303B*	19A134666P1	Prequency network: selective, 470-630 MHz res freq, 500 VDCW; sim to Dilectron TC501:NPO:240J:SLAC. Added to G2-G4 by REV A.
C2303	19A118656P18J8	Ceramic disc: 18 pF ±5%, 500 VDCW, temp coef -80 PPM.
C2305	19A116656P2OKO	Ceramic disc: 20 pF ±10%, 500 VDCF, temp coef 0 PPM.
C2306*	54900087127	Silver mica: 100 pF +10%, 500 VDCW, aim to Electro Motive Type DM-15.
	19A116679P100K	Earlier than REV A:
C2307*		Silver Mica: 100 pP ±10%, 250 VDCW,
C2307-	19A116656P24J0	Ceramic diac: 24 pF ±5%, 500 VDCW, temp coef 0 PPM. Earlier than REV A:
	19A116679P220K	Silver Wica: 220 pF ±10%, 250 VDCW.
C2308*	5490008P135	Silver mica: 220 pF +10%, 500 VDCW, aim to Electro Motive Type DM-15.
		Earlier than REV A:
	19A116679P100K	Silver Mica: 100 pF ±10%, 250 VDCW.
C2309	19A116656P3OJB	Ceramic disc: 30 pF ±5%, 500 VDCW, temp coef
C2310*	19A116658P20K0	-80 PPM. Ceramic disc: 20 pF +10%, 500 YDCW, temp coef 0 PPM. Deleted by REV A.
C2310A*	19A134666P2	Frequency network: selective, 480-700 MHz res freq, 500 VDCW; sim to Dilectron TC501:RPO:270J:SLAC. Added by REV B.
C2310B*	19A134666P1	Frequency network: selective, 470-630 MHz res freq. 500 VDCW; sim to Dilectron TC501:NPO:240J:SLAC. Added by REV B.
		JACKS AND RECEPTACLES
J2301	19A700049P2	Connector, receptable: 500 YDCF maximum; sim to MTTF-1058.
1,2301LL	19D413078G3	Helical resonator.
L2301L	19D413078G5	Helical resonator.
L2301M	19D413078G6	Helical resonator.
L2301 H	19D413078G7	Helical resonator.
123011M	19D413078G9	Helical resonator.
L2302*	19B209420P101	Coil, RF: .10 uH +10%, 0.8 ohms DC res max; sin to Jeffers 4416-1K.
	19A129716G4	Earlier than REV A: Coil.
P2301	19A702402P2	Contact, electrical; sim to AMP 42827-2.
P2302		(Part of W230t).

SYMBOL	PART NO.	DESCRIPTION
Q2301	19 A 116859P2	Silicon, NPN.
		RESISTORS
R2301	19A700106P91	Composition: 15K ohms ±5%, 1/4 w.
R2302*	19A700136P87	Composition: 10X ohms ±5%, 1/4 w.
		In REV A & exciter:
	19A700106P83	Composition: 6.8K ohms ±5%, 1/4 w.
R2303	19A700136P57	Composition: 560 ohms ±5%, 1/4 w.
12304	19A700106P39	Composition: 100 ohms ±5%, 1/4 w.
2305*	19A700196P63	Composition: 1K ohms ±5%, 1/4 w. In REV A:
	19 A70 0106P61	Composition: 820 ohms ±5%, 1/4 w. Added by REV A.
₩2301	5491689794	RF: approx. 3 inches long. (Includes P2302).
	0.1000/33	
		MISCELLANEOUS
	19E501121G1	Casting, RF Circuit.
	19B227101G1 19B209209P308	Cover, RF Circuit. Tan screw Phillips POZIDRIVE: No. 8-32 - 3/8
		Tap screw, Phillips POZIDRIV*: No. 6-32 x 3/8. (Secures RF Circuit Cover).
	19C328755P3	Screw. (Part of C301-C305),
	19C328755P2	Screw. (Part of C306-C308).
	19A143476G2 4031594P1	Nut: thd. size No. 6-32. (Part of C301-C308).
	198219470P2	Insulator, (Used with C504 on IP Filter Soard). Shield. (Used with IF Filter Board).
	19A129424G1	Can. (Used with 1401~1403, L501, L503, L504).
	19A127(60P2	Can. (Weed with L2301).
	4035306P59	Washer, fiber. (Used with PL501, PL502).
	403530(P23	Washer, fiber. (Used with J501, J2301).
	19A701332P1	Insulator disk. (Used with Q2301).
	4035306P11	Washer, fiber: 1/8 dia. (Used with 9501).
	403530€ P23	Washer, fiber. (Used with J501).

RF ASSEMBLY
198233690G1-G2
ISSUE 5

		13304 5	P1		(Part of W1).
			Q1	19A134093P1	N Type, field effect; sim to Type 2N4391. (Used in G3).
SYMBOL	PART NO.	DESCRIPTION	QI	19A700060P2	N Type, field effect. (Used 1a G4).
					RESISTORS
		STANDARD 198233690G1, 11 406-420 MHz	RI	3R151P102J	Composition: 1K ohms ±5%, 1/8 w.
		19B233690G2, 12 420-450 MHz 19B233690G3, 13 450-470 MHz			
		19B23369OG4, 14 470-494 MHz 19B23369OG5, 15 494-512 MHz	WA	4391689P114	Cable, RF: approx 5-1/2 inches long. (Includes P1).
		NON FLOATING GROUND ONLY 19823369066, 16 408-420 MHz			NETWORKS
		198233690G7, 17 420-450 MHz 198233690G8, 18 450-470 MHz 198233690G9, 19 470-494 MHz 198233690G10, 20 484-512 MHz	Z1	19A134666P1	Prequency network: selective, 470-630 MHz res. freq. 500 VDCW; sim to Dilectron TC501:NPO:240J:SLAC.
		RF CIRCUIT			
		19D417075G19, 29 406-420 MHz FLOATING GRD 19D417075G20, 30 420-450 MHz FLOATING GRD 19D417075G21, 31 450-470 MHz FLOATING GRD	C301 thru		Includes:
		19D417075G21, 31 450-470 MHz FLOATING GRD 19D417075G22, 32 470-494 MHz FLOATING GRD 19D417075G23, 33 494-512 MHz FLOATING GRD	C305	19C328755P3	Screw.
		19D417075G24, 34 408-420 MHz NON PLOATING GRD 19D417075G25, 35 420-450 MHz NON PLOATING GRD		19A143476G2	Nut: thd. size No. 6-32.
		19D417075G28, 38 450-470 MHz NON PLOATING GRD 19D417075G27, 37 470-494 MHz NON FLOATING GRD	C306 thru	19¢328755P2	Includes:
		19D417075G28, 38 494-512 MHz NON FLOATING GRD	C308	19C328755P2 19A143476G2	Nut: thd. size No. 6-32.
A301A		COMPONENT BOARD	C311	5496218P241	Ceramic disc: 10 pF ±5%, 500 VDCW, temp coef
and A301C		A301A 19B219942G1 A301C 19B219942G1	C325	198209488P1	-80 PPM. Ceramic: 6.8 pF ±20%, 500 VDCW; sim to Allen
					Bradley Style PASD.
C1	7484398P3	Silver mics: 250 pF ±10%, 500 VDCW; sim to Underwood Type 71HF.	C326	19B209488P2	Ceramic: 1000 pF -10+100%, 500 VDCW; sim Allen Bradley Style FASD,
C2	19A700015P37	Teflon/Mica: 220 pF ±5%, 250 VDCW.			
C3	19A118656P27J0	Ceramic disc: 27 pP ±5%, 500 VDCW, temp coef 0 PPM.	L301	19B204938G37	Coil.
		JACKS AND RECEPTACLES	L302 thru L304	19B219944P1	Coil.
J1	7104841916	Jack, phono: conximl.	L305	19B204938G33	Co11.
		RESISTORS	L306 and	19B219944P5	Co11.
R1	19A700108F79	Composition: 4.7% ohms ±5%, 1/4 w.	L307		
			L308	19B204938G41	Co11.
▲301B		ANTENNA INPUT PLATE 19A137683G2	L311	19B204938G38	Co11.
		JACKS AND RECEPTACLES	L312 thru L314	19821994492	Co11.
J1	7104941P20	Jack, phono: conxint.	L315	19B204938G34	Co11.
A305		MIXER BOARD	L316 and L317	198219944P6	Coil.
		198227059G3, G4	L318	19B204938G42	Coil.
			L321	19 8204 938G39	Co11.
C2	194700012P1	Variable, ceramic: 2 to 10 pF, 200 VDCW, temp coef ~350+500 PPM; sim to Panasonic ECV-1ZW10X32.	L322 thru L324	198219944P3	Co11.
C5	19A116192P1	Ceramic: 0.01 uF ±20%, 50 VDCW; sim to Erie 8121 Special.	£325	19B204938G35	Coil.
C6	194700219939	Ceramic: 20 pF ±5%, 100 VDCW, temp coef 0 PPM.	L326 and	198219944P7	Coil.
C7	19A700219P14	Ceramic: 3.3 pF ±5%, 100 VDCW, temp coef 0 PPM.	L327 L328	199204938G43	Ceil.
		INDUCTORS	L328	198204938G40	Coil.
L1		(Part of Printed Board 19D429194P1).	£332	198219944P4	Coil.
L2	19A700122P1	Torridal core.	thru L334		
******	LENTS ADDED DE	LETED OR CHANGED BY PRODUCTION CHANGES	. L		

*COMPONENTS ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES $^{f L}$

LBI-30032 PARTS LIST

SYMBOL	PART NO.	DESCRIPTION
L335	198204938G36	Coil.
L336	19B219944P8	Coil.
1337		
L338	198204938644	Coil.
£351	198204938G47	Coil.
L352 tbru	198219944P9	Col1.
L354	198204938P48	
1,355 L356	198204938P48	Coil.
and 1,357		
L356	198204938P49	Co11.
		IF FILTER BOARD 19033114801 19033114802
		* CAPACITORS
C502	T644ACP322K	Polyester: 0.022 uF ±10%, 50 VDCW.
C503	19A701534P8	Tantalum: 22 uP ±20%, 16 VDCW.
C504	194700012P1	Variable, ceramic: 2 to 10 pF, 200 VDCW, temp coef -350+500 PPM; sim to Panasonic ECV-1ZW10X32
C505	19&143477P17	coef -350+500 PPM; sim to Panasonic ECV-12W10X32 Polyester: 0.22 uF 220%, 50 VDCW.
thru C508	10814347777	Polyester. 0.22 ar 320x, 30 voce.
C509	5490008P139	Silver mica: 330 pP ±10%, 500 VDCW, sim to Electro Motive Type DM-15.
C510	194700233P7	Ceramic: 1000 pF ±20%, 50 VDCW.
C511		(Part of L503).
C512	19A116656P20K0	Ceramic disc: 20 pF ±10%, 500 VDCW, temp coef 0 PPM.
C513	194700233P7	Polyester: .010 uF ±10%, 50 VDCW
C514 C515	5490008P24	Ceramic: 1000 pF ±20%, 50 VDCW.
0010	5450000724	Silver mica: 75 pF ±5%, 500 VDCW, mim to Electro Motive Type DM-15.
C516	194702236P25	Ceramic: 10 pP ±0.5 pP, 50 VDCW, temp coef 0 ± 30 PPM/°C.
CR501	19A700047P1	Silicon, 100 mW continues dissapation.
PL501	19B219573G3	Crystal: Resonator A - 11,200.000; Resonator B - 11,196.024 kHz.
FL502		(Part of FL501).
		JACKS AND RECEPTACLES
J501	19A700049P2	Connector, receptacle: 500 VDCW maximum; sim to NTTF-1058.
J502	4033513P1	Contact, electrical: sim to Bead Chain L93-4.
J503 and J504	19A116975P1	Contact, electrical.
3309		
L503	19C320141G4	Coil, includes:
	5493185P9	Tuning slug.
L504	190320141629	Coil. Includes:
	5493185P9	Tuning slug.
L505	19A700024P25	Coil, RF: 10.0 uH ±10%, 3.70 ohms DC res max.
L506		(Part of Printed Board 19C331147P1).
L507	19032181061	Co11.
L508	19A700000P114	Coil, RF: 1.5 uH ±10%; sim to Jeffers 4412-7K.
		PLUGS
P501		(Part of #501).

SYMBOL	PART NO.	DESCRIPTION
		TRANSISTORS
Q 501	194116818P4	N Channel, field effect.
R501	19A700106P87	Composition: 10% ohms ±5%, 1/4 w.
R502	19A700106P77	Composition: 3.9K ohms ±5%, 1/4 w.
R503	19A700106P47	Composition: 220 ohms ±5%, 1/4 w.
R504	19A700106P31	Composition: 47 ohms ±5%, 1/4 w.
R506	19A700106P71	Composition: 2.2K ohms ±5%, 1/4 w.
		CABLES
₹501	19A129947G7	Cable: orange, No. 22 stranded, approx. 7-1/2 inches. (Includes P501).
	19850112161	Casting, RP Circuit.
	198227101G1	Cover, RF Circuit.
	1982092099306	
		Tap screw, Phillips POZIDRIY*: No. 6-32 x 3/8. (Secures RF Circuit Cover).
	19C328755P3	Screw. (Part of C301-C305).
	19C328755P2 19A143476G2	Screw. (Part of C306-C308). Nut: thd. size No. 6-32, (Part of C301-C308).
	4031594P1	Insulator. (Used with C504 on IF Filter Board)
	198219470P2	Shield. (Deed with IF Filter Board).
	19 4129424 G1	Can. (Used with 1503, 1504, 1507).
	4035306P59	Washer, fiber. (Used with FLS01, FL502).
	4035306P23	Washer, fiber. (Used with J501).
	4035306P11	Washer, fiber: 1/8 dia. (Used with Q501).
	19A129715G1	Adapter Board.

PRODUCTION CHANGES

Changes in the equipment to improve performance or to simplify circuits are identified by a "Revision Letter", which is stamped after all the model number of the unit. The revision stamped on the unit includes all previous revisions. Refer to the Parts List for descriptions of parts affected by these revisions.

REV. A - RF Assembly 19D417075G0-12

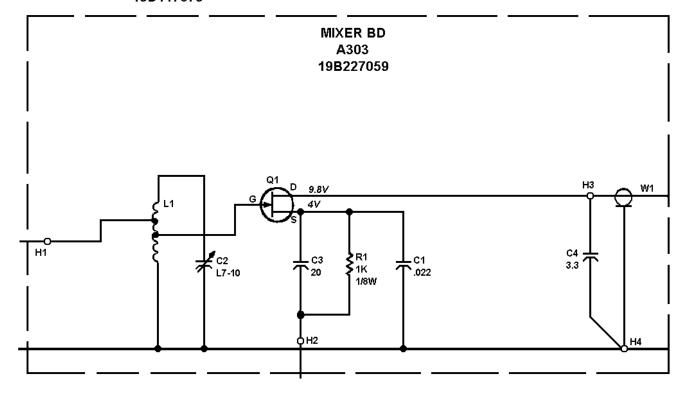
To improve receiver sensitivity. Changed C4.

REV. B - <u>RF Assembly 19D417075G0-12</u>

To incorporate new mixer board. Replaced A303 (19B227059G1) with A304 (19B227059G2).

Schematic Diagram Was:

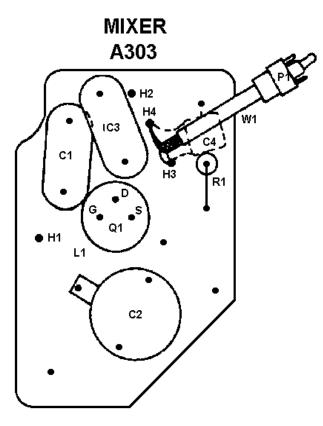
RF ASSEMBLY 19D417075



PARTS LIST LBI-30032

PRODUCTION CHANGES - (Continuation)

Outline Diagram Was:



REV. A - IF - Filter Board 19C320523G2

To improve operation. Replaced L502 with L508, added C516.

REV. A - RF Assembly 19D417075G13-G16

REV. C - RF Assembly 19D417075G9-G12

To improve sensitivity. Deleted A304-C4.

REV. D - RF Assembly 19D417075G9

To improve receiver sensitivity in 406 to 420 MHz range. Added A301C.

REV. A - UHS Pre-Amplifier

To incorporate new coil (L2302). Changed L2302, C2302, C2306, C2307 and C2308. Deleted C2310 and added R2305.

REV. B - UHS Pre-Amplifier

To improve receiver sensitivity. Changed R2302 and R2305. Added C2310.

REV. A - RF Assembly 19D417075G19-G28

IF Filter Board 19C331148G1

To improve operation of UHF mixer circuit. Added C7 and L2.

REV. B - UHS Pre-Amplifier

To improve receiver sensitivity. Changed R2302 and R2305. Added C2310.

REV. A - IF - Filter Board 19C331148G2

Q501 no longer available. Was 19A116818P1. Added C516.